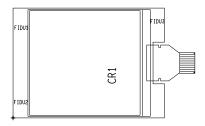
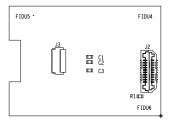
ART FILM - assembly\_top



ART FILM - assembly\_top

## ART FILM - assembly\_bottom\_mirrored



ART FILM - assembly\_bottom\_mirrored

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